

DO NOT SCALE DRAWING

EC NO. DRWN: CH'K: APPR:	EC NO. DRWN: CH'K: APPR:	EC NO. DRWN: CH'K: APPR:	EC NO. DRWN: CH'K: APPR:	EC NO. DRWN: CH'K: APPR:	EC NO.-J2004-3185 DRWN: T.UENO CH'K: M.SASAO APPR: M.SASAO RELEASED '04/03/18	MATERIAL 材料 SEE NOTES FINISH 仕上り SEE NOTES WIRE RANGE 適用電線範囲 INS. RANGE 被覆外径	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差 10 UNDER 未満 ±0.2 10 OVER 30 UNDER 未満 ±0.25 30 OVER 以上 ±0.3 ANGLE 角度 ±3°	SCALE DESIGN UNITS <input checked="" type="checkbox"/> mm <input type="checkbox"/> INCH THIRD ANGLE PROJECTION DRAWN BY & DATE T.UENO '04/03/18 CHECKED BY & DATE M.SASAO '04/03/18 APPROVED BY & DATE M.SASAO '04/03/18 CAD FILENAME SD-55244-009.S01	DIMENSIONS: <input type="checkbox"/> mm <input type="checkbox"/> INCH <input checked="" type="checkbox"/> mm ONLY TITLE: CF CARD CONN. 50P HEADER ASS'Y (NORMAL TYPE) -LEAD FREE- MOLEX MOLEX INCORPORATED	SHT REVISE ON CAD ONLY MATERIAL NO. 55244-5029 DRAWING NO. SD-55244-009 SHEET NO. 1 OF 2
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DWG. NO. SD-55244-009

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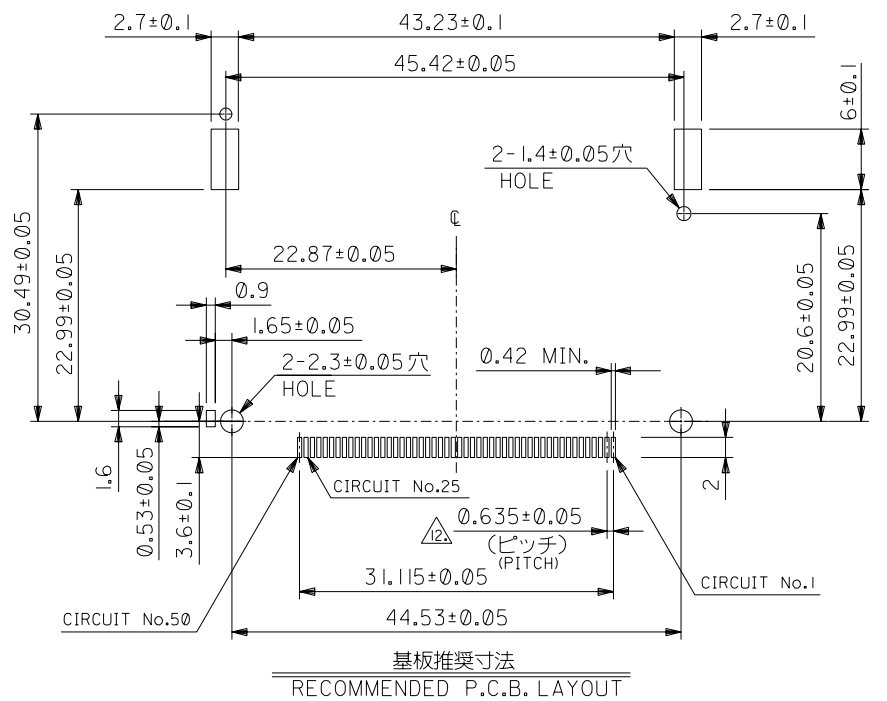
注) NOTES

1. 材質 MATERIAL
 ハウジング : ガラス入り耐熱樹脂 UL94V-0
 HOUSING : LIQUID CRYSTAL POLYMER GLASS FILLED UL94V-0
 ピン : リン青銅
 PIN : PHOSPHOR BRONZE
 ネール : リン青銅
 NAIL : PHOSPHOR BRONZE

2. メッキ仕様 PIN 接点部 金めっき
 PLATING CONTACT AREA GOLD PLATING
 半田付け部 錫めっき
 SOLDER TAIL AREA TIN PLATING
 下地めっき ニッケルめっき
 UNDERPLATING NICKEL PLATING
 NAIL 接点部 金めっき
 CONTACT AREA GOLD PLATING
 半田付け部 錫めっき
 SOLDER TAIL AREA TIN PLATING
 下地めっき ニッケルめっき
 UNDERPLATING NICKEL PLATING

3. 推奨基板厚 : $t \pm 0.8$ MIN.
 RECOMMENDED P.C.B. THICKNESS: $t \pm 0.8$ MIN.
 4. 適合カード厚 : 3.3 ± 0.1 (TYPE I) AND 5 MAX. (TYPE II)
 RECOMMENDED CARD THICKNESS: 3.3 ± 0.1 (TYPE I) AND 5 MAX. (TYPE II)
 5. 適合カード幅 : 42.8 ± 0.1
 RECOMMENDED CARD WIDTH: 42.8 ± 0.1
 6. ハウジング色 : 黒
 HOUSING COLOR: BLACK

△1. 寸法適用極 : 1,13,38,50
 THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 1,13,38 AND 50.
 △2. 寸法適用極 : 25,26
 THIS DIMENSION APPLIES TO CIRCUIT NUMBERS 25 AND 26.
 △3. ピンの倒れは、ピン根元を基準に全方向へ 0.1 MAX.とする。
 PIN TIP LEAN TOWARD ANY DIRECTION NOT TO EXCEED 0.1 WHEN MEASURED FROM PIN BASE.
 △10. ピン根元に適用する。
 THIS DIMENSION TO BE MEASURED AT PIN BASE.
 △11. ソルダータール及びネールは、Z面を基準とし上へ 0.05 下へ 0.15 の範囲にあり、且つソルダータールの平坦度は、 0.12 MAX. とし、テール先端にて測定する。
 SOLDER TAILS AND FITTING NAILS TO BE WITHIN 0.05 UPWARD AND 0.15 DOWNWARD FROM Z-DATUM PLACE, AND COPLANARITY OF SOLDER TAILS TO BE WITHIN 0.12 . MEASUREMENT POINT IS SOLDER TAILS TIP.



- △12. 公差非累積
NON-CUMULATIVE
- △13. テールとネールを併せた平坦度は、 0.12 MAX.とする。
TOTAL COPLANARITY OF SOLDER TAILS AND FITTING NAILS TO BE 0.12 MAX.
- △14. ボタンストロークが (6 mm) の時、カード飛び出し量は (3.25mm)。
WHEN BUTTON PUSH STROKE IS (6mm), CARD OUT BY (3.25mm).
- 15. 適合 SHEEL ASS'Y : 55246-001* , 58773-0010
APPLICABLE SHEEL ASS'Y : 55246-001* , 58773-0010
- 16. 本製品は 55244-5021 の鉛フリー品である。
THIS PRODUCT IS LEAD FREE OF 55244-5021.

↑	EC NO.	DRAWN:	CHK'G:	APPR:	SEE SHEET 1 OF 2	MATERIAL 材料	SEE NOTES	GENERAL TOLERANCES: (UNLESS SPECIFIED) 一般公差	SCALE	DESIGN UNITS	THIRD ANGLE PROJECTION	DIMENSIONS: <input type="checkbox"/> mm <input type="checkbox"/> INCH <input checked="" type="checkbox"/> mm ONLY	SHT	REV			
	EC NO.	DRAWN:	CHK'G:	APPR:		FINISH 仕上げ	SEE NOTES	10 UNDER 未満	1:1	mm	mm	mm					
	EC NO.	DRAWN:	CHK'G:	APPR:		WIRE RANGE 適用電線範囲	—	10 OVER 30 UNDER 未満	1:2	mm	mm	mm					
	EC NO.	DRAWN:	CHK'G:	APPR:		INS. RANGE 被覆外径	—	30 OVER 以上	1:3	mm	mm	mm					
TITLE: CF CARD CONN. 50P HEADER ASS'Y (NORMAL TYPE) -LEAD FREE-												MATERIAL NO. 55244-5029		DRAWING NO. SD-55244-009		SHEET NO. 2	
MOLEX INCORPORATED												THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION.				SIZE B	